

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOS V)**2SK2837**

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

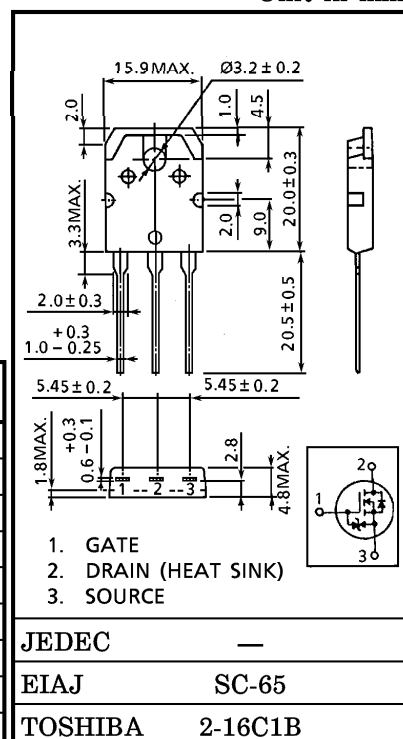
INDUSTRIAL APPLICATIONS

Unit in mm

- Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.21\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 17S$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100\mu A$ (Max.) ($V_{DSS} = 500V$)
- Enhancement-Mode : $V_{th} = 2.0 \sim 4.0V$ ($V_{DS} = 10V$, $I_D = 1mA$)

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Drain-Gate Voltage ($R_{GS} = 20k\Omega$)		V_{DGR}	500	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	DC	I_D	20	A
	Pulse	I_{DP}	80	A
Drain Power Dissipation ($T_c = 25^\circ C$)		P_D	150	W
Single Pulse Avalanche Energy**		E_{AS}	960	mJ
Avalanche Current		I_{AR}	20	A
Repetitive Avalanche Energy*		E_{AR}	15	mJ
Channel Temperature		T_{ch}	150	$^\circ C$
Storage Temperature Range		T_{stg}	$-55 \sim 150$	$^\circ C$



Weight : 4.6g

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	0.833	$^\circ C / W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	50	$^\circ C / W$

Note ;

* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

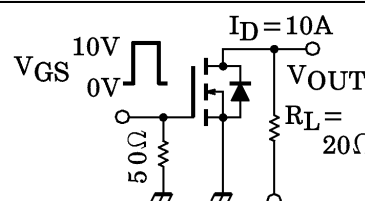
** $V_{DD} = 90V$, Starting $T_{ch} = 25^\circ C$, $L = 4.08mH$
 $R_G = 25\Omega$, $I_{AR} = 20A$

This transistor is an electrostatic sensitive device.
Please handle with caution.

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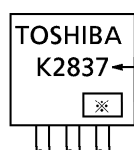
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I _{GSS}	V _{GS} =±25V, V _{DS} =0V	—	—	±10	μA
Gate-Source Breakdown Voltage		V (BR) GSS	I _G =±10μA, V _{DS} =0V	±30	—	—	V
Drain Cut-off Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V	—	—	100	μA
Drain-Source Breakdown Voltage		V (BR) DSS	I _D =10mA, V _{GS} =0V	500	—	—	V
Gate Threshold Voltage		V _{th}	V _{DS} =10V, I _D =1mA	2.0	—	4.0	V
Drain-Source ON Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =10A	—	0.21	0.27	Ω
Forward Transfer Admittance		Y _{fs}	V _{DS} =10V, I _D =10A	10	17	—	S
Input Capacitance		C _{iss}	V _{DS} =10V, V _{GS} =0V, f=1MHz	—	3720	—	pF
Reverse Transfer Capacitance		C _{rss}		—	340	—	
Output Capacitance		C _{oss}		—	1165	—	
Switching Time	Rise Time	t _r		—	30	—	ns
	Turn-on Time	t _{on}		—	70	—	
	Fall Time	t _f		—	50	—	
	Turn-off Time	t _{off}		—	290	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q _g	V _{DD} ≐400V, V _{GS} =10V, I _D =6A	—	80	—	nC
Gate-Source Charge		Q _{gs}		—	48	—	
Gate-Drain (“Miller”) Charge		Q _{gd}		—	32	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	20	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	80	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = 20A, V_{GS} = 0V$	—	—	-1.7	V
Reverse Recovery Time	t_{rr}	$I_{DR} = 20A, V_{GS} = 0V$ $dI_{DR}/dt = 100A/\mu s$	—	540	—	ns
Reverse Recovery Charge	Q_{rr}		—	5.4	—	μC

MARKING



TYPE

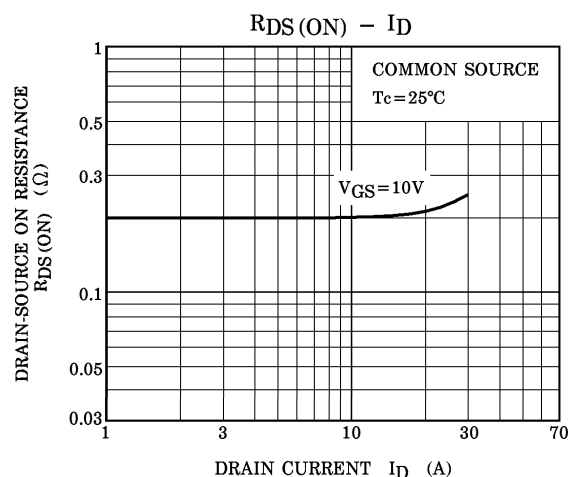
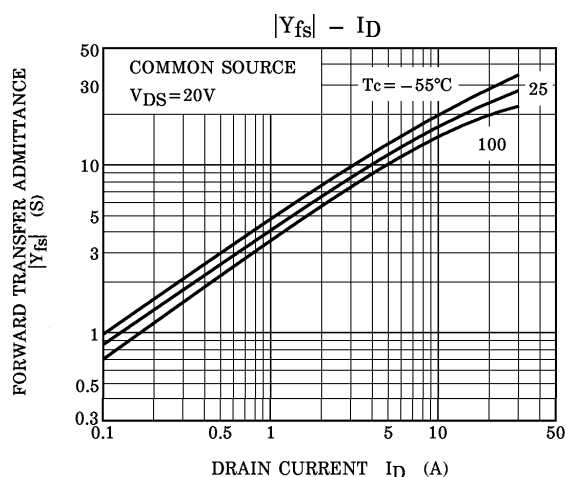
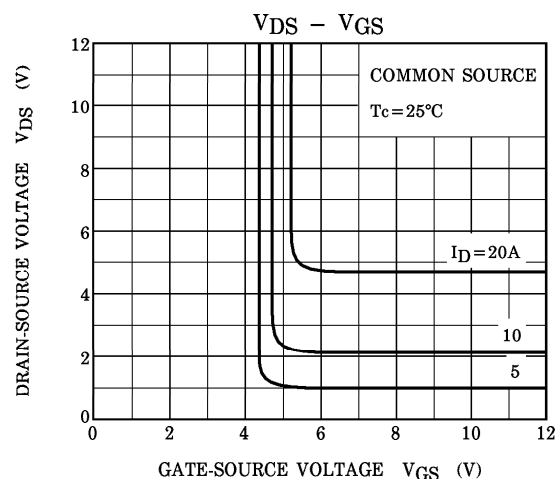
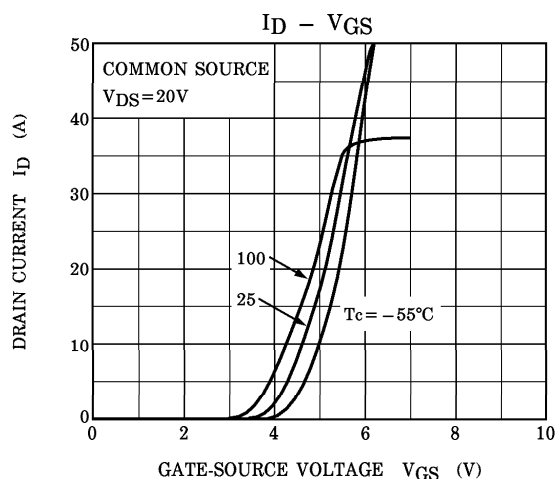
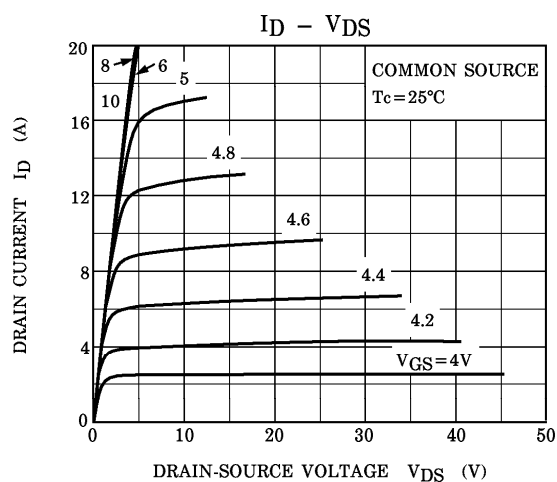
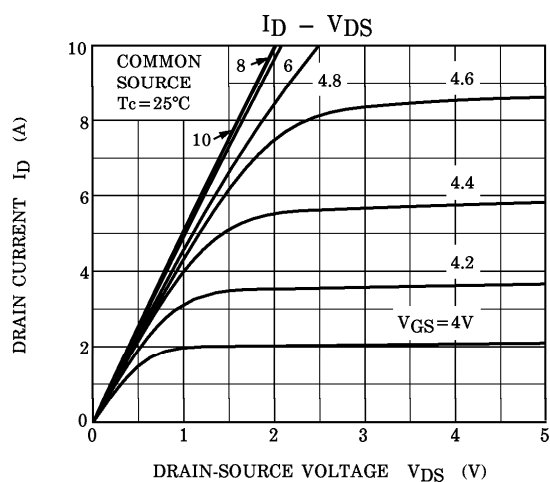
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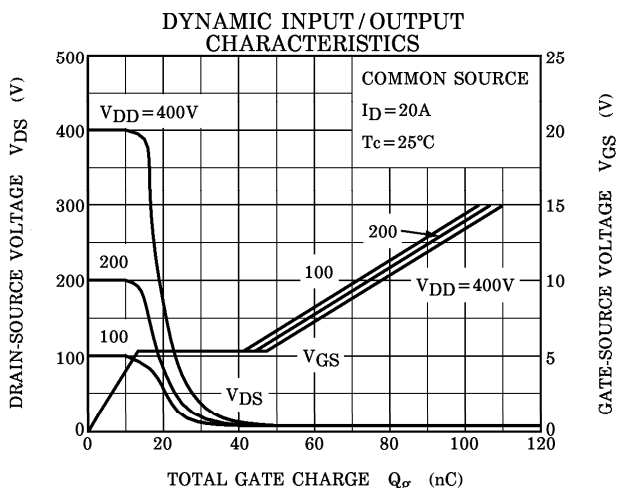
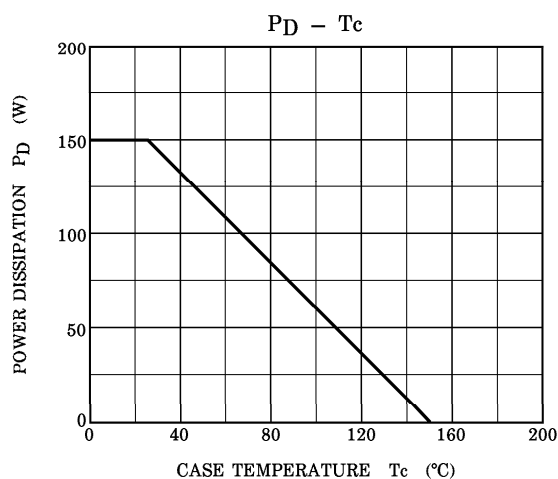
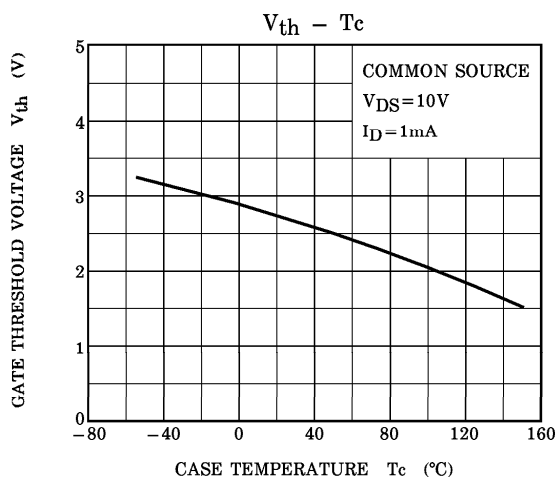
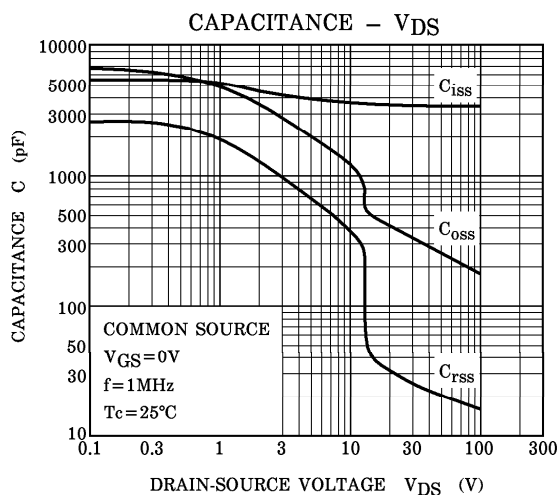
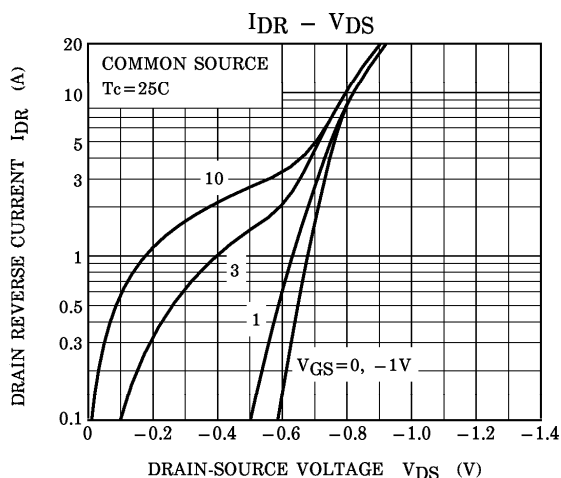
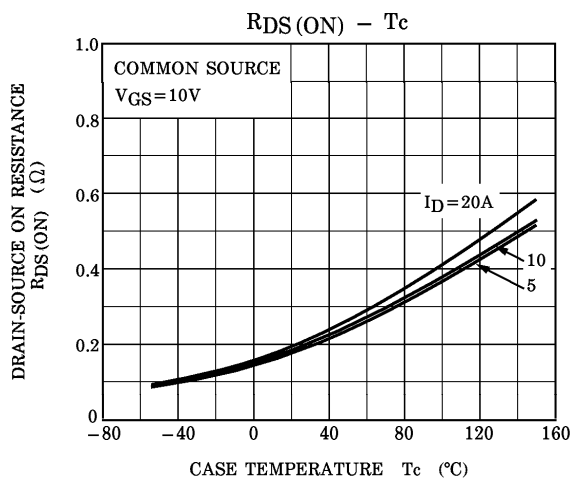


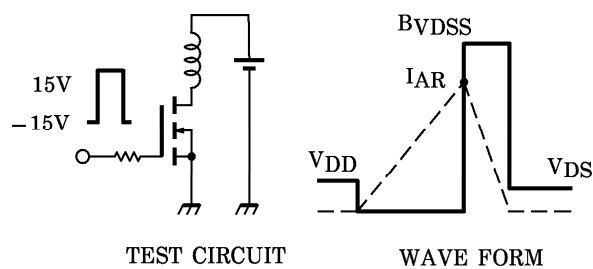
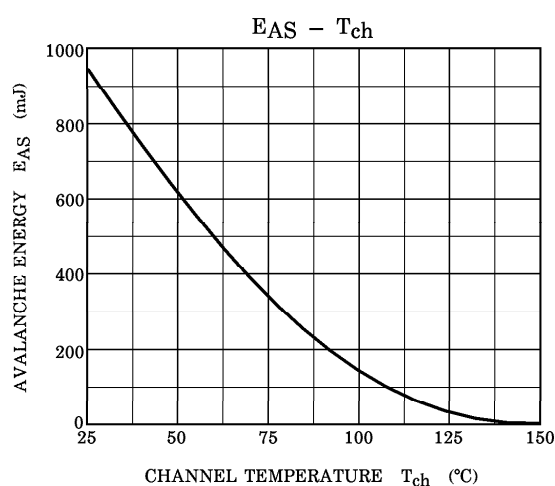
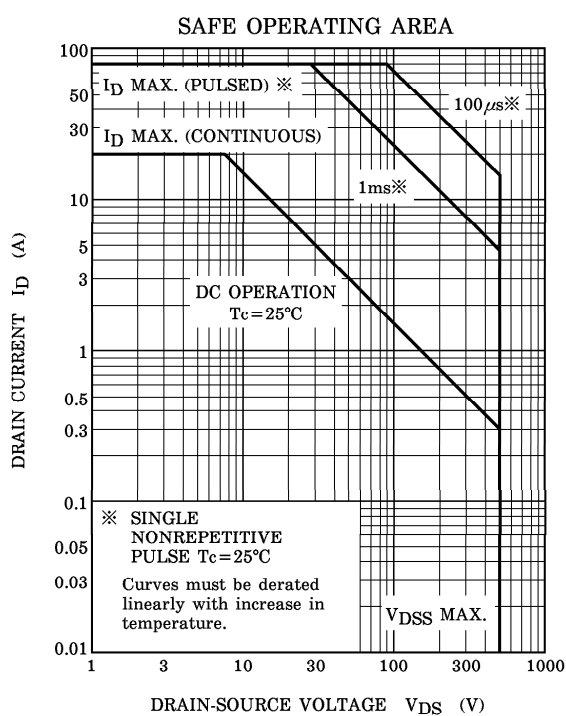
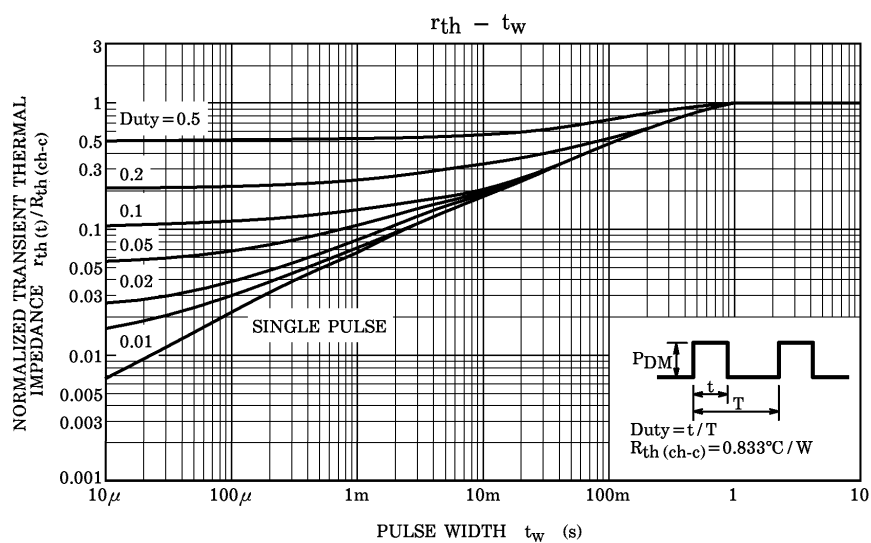
Month (Starting from Alphabet A)



Year (Last Number of the Christian Era)







Peak $I_{AR} = 20A$, $R_G = 25\Omega$, $V_{DD} = 90V$, $L = 4.08mH$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$$